Overview

1. External 5.25” bay
2. External/internal shared 3.5” bay
3. Power button
4.. Front I/O (in top to bottom order): 4 USB 2.0 port, Headphone, Microphone
5. SFF tower stand (optional)

Form Factor	Small Form Factor
Operating Systems	Preinstalled: • Genuine Windows® 7 Ultimate 64-bit • Genuine Windows® 7 Professional 32/64 • Genuine Windows® 7 Home Premium 32/64 • HP Installer Kit for Linux [includes drivers for 64-bit OS versions of Red Hat Enterprise Linu 6 and SUSE Linux Enterprise Desktop (SLED) 11] • SUSE Linux Enterprise Desktop 11 64-bit • Red Hat Enterprise Linux Workstation (1 year paper license available; Preinstall not available) Supported: • Genuine Windows® 7 Enterprise 32/64 • Genuine Windows® XP Professional 32/64* * See the “Windows XP Support Matrix for Z Workstations” at: http://www.hp.com/support/workstation_manuals **NOTES:** For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Overview

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology[1]	Cache (MB)	Memory Speed (MHz)	Hyper-Threading	Integrated Graphics	Featuring Intel® vPro™ Technology	TDP (W)
Intel® Xeon® processor E3-1280v2	4	3.6	4.0	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1270v2	4	3.5	3.9	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1245v2	4	3.4	3.8	8	1600	Y	Intel HD Graphics P4000	Y	77W
Intel® Xeon® processor E3-1240v2	4	3.4	3.8	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1230v2	4	3.3	3.7	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1225v2	4	3.2	3.6	8	1600	N	Intel HD Graphics P4000	Y	77W
Intel® CoreTM i7-3770 processor	4	3.4	3.9	8	1600	Y	Intel HD Graphics 4000	Y	77W
Intel® Pentium® G640 processor	2	2.8	N/A	3	1066	N	Intel HD Graphics	N	65W

[1]The specifications shown in this column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

Available Processor Disclaimers	Integrated Intel® HD graphics is not supported on the Intel® Xeon E3-1230v2, E3-1240v2, E3-1270v2 or E3-1280v2 Processors. Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory. Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details. 64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipse BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information. Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
Color	Jack Black
Convertibility	The Z220 SFF can either be placed flat on the desktop or made to stand on the desk with the optional tower stand.
Expansion Slots (see system board section for more details)	• 1 PCIe Gen3 x16 slot • 1 PCIe Gen2 x4 slot /x16 connector • 1 PCIe Gen2 x1 slot • 1 PCI (all slots are Low Profile) **NOTE:** In the PCIe Gen3 x16 slot, if it is not being used for a graphics card, only cards certified a After Market Options for this platform are supported.

Overview

Expansion Bays (see storage section for more details)	• 1 internal 3.5" bay, and 1 shared internal/external 3.5" bay. • 1 external 5.25" bay.
Front I/O	4 USB 2.0, 1 Headphone, and 1 Microphone
Internal I/O	4 USB 2.0 ports available by two separate 9-pin headers
Rear I/O	1 VGA and 1 DisplayPort output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).
Interfaces Supported	22-in-1 Media Card Reader (optional)
Chassis Dimensions (H x W x D)	Standard desktop orientation: 100 x 338 x 381 mm (3.95 x 13.3 x 15.0 in); Optional SFF Tower orientation (excluding stand dimension): 338 x 100 x 381 mm (13.3 x 3.95 x 15.0 in)
Weight	Exact weights depend upon configuration; Typical Weight* 7.5 kg (16.5 lbs) Shipping Weight* 8.1 kg (17.86 lbs) Max Supported Weight (desktop orientation) 35 kg (77 lb) *Configured with 1 3.5" hard drive, 1 optical drive, 2 DIMMs and 1 NVIDIA NVS 300 graphics card
Temperature	Operating: 40° to 95°F (5° to 35°C) Non-operating: -40° to 140°F (-40° to 60°C)
Humidity	Operating: 8% to 85% Non-operating: 8% to 90%
Maximum Altitude (non-pressurized)	Operating: 3,000 m (10,000 ft) Non-operating: 9,100 m (30,000 ft).
Power Supply	240 watts wide-ranging, active Power Factor Correction, 90% Efficient The Power Supply Efficiency Report for this product may be found at these links: http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_PS-4241-9HB_ECOS%202398_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_PC9055-020H_ECOS%202342_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_D10-240P1A_ECOS%202307_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HP_DPS-240TB%20A_ECOS%202299_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_CFH240EWWB_ECOS%202304_240W_Report.pdf
Backup Devices	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit: http://www.hp.com/go/connect
Chipset	Intel® C216 chipset
Memory	4 DIMM slots, supporting up to 32GB ECC/non-ECC, DDR3 1600 MHz
Memory disclaimers	The CPUs determine the speed at which the memory is clocked. If a 1066 MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the specified speed of the memory.
Workstation ISV Certifications	See the latest list of certifications at: http://www.hp.com/united-states/campaigns/workstations/partnerships.html

Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel® Xeon® processor E3 v2 family (Z220)				
Intel® Xeon® processor E3-1280v2, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
Intel® Xeon® processor E3-1270v2, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
Intel® Xeon® processor E3-1245v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
Intel® Xeon® processor E3-1240v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
Intel® Xeon® processor E3-1230v2, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
Intel® Xeon® processor E3-1225v2, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology	Y	N		See Note 2
3rd generation Intel® Core™ processor family				
Intel® Core™ i7-3770 processor, Quad-Core, 8 MB cache, 3.4GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Y	N		See Note 3
Dual-Core Intel Pentium processors (Z220)				
Intel® Pentium® G640 processor, Dual-Core, 3 MB cache, 2.8 GHz	Y	N		See Note 2

NOTE 1: Intel HD Graphics P4000 provides improved desktop performance and supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications*, compared to Intel HD Graphics 4000 or Intel HD Graphics 2500.
NOTE 2: These processors support either ECC or non-ECC memory
NOTE 3: These processors support only non-ECC memory

Monitors / Displays

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP DreamColor LP2480zx Professional Display				
HP ZR30w 30-inch S-IPS LCD Monitor				
HP ZR2740w 27-inch LED Backlit IPS Monitor				
HP ZR24w 24-inch S-IPS LCD Monitor				
HP ZR2440w 24-inch LED Backlit IPS Monitor				
HP ZR2240w 21.5-inch LED Backlit IPS Monitor				
HP ZR2040w 20-inch LED Backlit IPS Monitor				

Supported by all Operating Systems available from HP

Screen Size Diagonally Measured

Supported Components

Hard Drives

		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
SATA Hard Drives					
	SATA (Serial ATA) Hard Drives for HP Workstations				
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ034AA	
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA	
	300GB SATA 10K rpm SFF in 3.5" Frame HDD	Y	Y	FM802AA	
SATA Solid State Drives	**HP Solid State Drives (SSDs) for Workstations**				
	HP 160GB SATA SSD	Y	Y	LZ704AA	
	HP 300GB SATA SSD	Y	Y	LZ069AA	
	HP 128GB SATA SSD	Y	Y	A3D25AA	
	HP 256GB SATA SSD	Y	Y	A3D26AA	
	Intelligent Disk Caching				
	24GB SSD Disk Cache Module	Y	Y		

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA Controller (Z220)				
	Integrated SATA Controller (SFF), RAID 0,1 supported: 2 ports 3 Gb/s, 2 ports 6 Gb/s	Y	N		
	Factory integrated RAID on motherboard for SATA drives				
	RAID 0 Configuration - Striped Array	Y	N		
	RAID 1 Configuration - Mirrored Array	Y	N		

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit:
http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.
All drives must be identical in type and capacity.
Boot/OS volume if configured as RAID array must be less than 2 TB.
NOTE 1: Requires identical hard drives (speeds, capacity, interface).

Supported Components

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Support Multi Mixed
Integrated Intel HD Graphics Media Accelerators (Z220)					
Intel HD Graphics P4000	Y	N			1
Intel HD Graphics 4000	Y	N			1
Intel HD Graphics	Y	N			1
Professional 2D					
NVIDIA NVS300 512MB PCIe Graphics Card	Y	Y	XP612AA		2
NVIDIA NVS 310 512MB Graphics Card	Y	Y	A7U59AA		2
Entry 3D					
AMD FirePro V3900 1GB Graphics Card	Y	Y	A6R69AA		1
NVIDIA Quadro 600 1GB Graphics Card	Y	Y	WS093AA		1
NVIDIA Quadro 410 512MB Graphics	Y	Y	A7U60AA		1

Intermixing integrated Intel HD graphics and discrete graphics cards in order to drive more than tw displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics cards when attaching three or more displays.

Memory

Sub-Section Description/Notes

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

CTO	Option Kit Part Number	Support Notes
DDR3-1600 nECC Unbuffered DIMMs CTO		
HP 32GB (4x8GB) DDR3-1600 nECC RAM		
HP 16GB (4x4GB) DDR3-1600 nECC RAM		
HP 12GB (2x4GB+2x2GB) DDR3-1600 nECC RAM		
HP 8GB (2x4GB) DDR3-1600 nECC RAM		
HP 8GB (4x2GB) DDR3-1600 nECC RAM		
HP 4GB (2x2GB) DDR3-1600 nECC RAM		
HP 2GB (1x2GB) DDR3-1600 nECC RAM		
DDR3-1600 ECC Unbuffered DIMMs - CTO		
HP 32GB (4x8GB) DDR3-1600 ECC RAM		
HP 16GB (4x4GB) DDR3-1600 ECC RAM		
HP 12GB (2x4GB+2x2GB) DDR3-1600 ECC RAM		
HP 8GB (2x4GB) DDR3-1600 ECC RAM		
HP 8GB (4x2GB) DDR3-1600 ECC RAM		
HP 4GB (2x2GB) DDR3-1600 ECC RAM		
HP 2GB (1x2GB) DDR3-1600 ECC RAM		

Sub-Section Description/Notes

Two channels of DDR3 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.
The CPUs determine the speed at which the memory is clocked. If a 1066 MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the specified speed of the memory.

AMO	Option Kit Part Number	Support Notes
DDR3-1600 nECC Unbuffered DIMMs AMO		

Supported Components

HP 8GB (1x8GB) DDR3-1600 non-ECC RAM	B1S54AA
HP 4GB (1x4GB) DDR3-1600 nECC RAM	B1S53AA
HP 2GB (1x2GB) DDR3-1600 nECC RAM	B1S52AA
DDR3-1600 ECC Unbuffered DIMMs - AMO	
HP 8GB (1x8GB) DDR3-1600 ECC RAM	
HP 4GB (1x4GB) DDR3-1600 ECC RAM	
HP 2GB (1x2GB) DDR3-1600 ECC RAM	

NOTE: Only unbuffered DDR3 DIMMs are supported.

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Thin USB Powered Speakers, BFR-PVC free	Y	Y	KK912AA	
Integrated Realtek HD ALC221 Audio	Y	N		

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP 16X DVD-ROM SATA Drive (non Lightscribe)	Y	Y	AR629AA	
HP 16X DVD+/-RW SuperMulti SATA Drive (non-Lightscribe)	Y	Y	QS208AA	
HP Blu-ray Writer	Y	Y	AR482AA	
HP 22-in-1 Media Card Reader Kit (Workstations)	Y	Y	NK361AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.
As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP IEEE 1394b FireWire PCIe Card	Y	Y	NK653AA	See Note 1
HP USB 3.0 2x2 Port SuperSpeed PCIe x1 Card	N	Y	QT587AA	See Note 2

NOTE 1: For the Z220 SFF Workstation, this card is only supported on Slots 1 or 2
NOTE 2: Four USB 3.0 ports are available integrated on the motherboard (rear access). Integrated USB 3.0 ports are supported under Microsoft Windows 7 operating system only. The USB 3.0 2x2 Port SuperSpeed PCIe card is required if Microsoft Windows XP or Linux operating systems support is required (supported as AMO only).

Supported Components

Networking and Communications	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Intel 82579LM PCIe GbE Controller	Y	N		
Intel Gigabit CT Desktop NIC	Y	Y		

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.
The Intel Gigabit CT NIC is supported on the following operating systems:
Microsoft Windows XP Pro 32-bit and 64-bit and Microsoft Windows 7 32-bit and 64-bit versions.
Red Hat Enterprise Linux(RHEL),
SLED 11

NOTE 2: The integrated network connection is required to support Intel vPro Technology.

NOTE 3: If AMT is enabled network teaming with the built in LAN port is not possible.

Racking and Physical Security	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Security Cable with Kensington Lock	N	Y	PC766A	
HP 2009 (SFF) Solenoid Lock and Hood Sensor	Y	Y		
HP Business PC Security Lock Kit	N	Y	PV606AA	

Input Devices	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP PS/2 Keyboard	Y	Y		
HP USB Keyboard	Y	Y		
HP USB CCID SmartCard Keyboard	Y	Y	BV813AA	
HP 2.4GHz Wireless Keyboard & Mouse	N	Y	NB896AA	
HP USB Optical 3-Button Mouse	Y	Y	DY651A	
HP USB 1000dpi Laser Mouse	Y	Y		
HP PS/2 Mouse	Y	Y		
HP USB Optical Mouse	Y	Y		
HP SpaceExplorer 3D USB Controller	N	Y	RY429AA	

Supported Components

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Power Cord Kit	N	Y	DM293A	
HP Workstation Mouse Pad	Y	N		Japan only
HP Serial Port Adapter	Y	Y	PA716A	
HP ENERGY STAR 5.0 Enabled Configuration	Y	N		
HP Parallel Port Adapter Kit	N	Y	KD061AA	
HP Internal USB Port Kit	N	Y		
HP eSATA PCI Cable Kit	Y	Y	FH966AA	
HP 2009 (SFF) Chassis Tower Stand	Y	Y	VN569AA	

Software

	Factory Configured	Option Kit	Option Kit Part Number	Suppo Notes
HP Performance Advisor	Y	N		See No 1
HP Remote Graphics Software (RGS) V5	Y	N		See No 2
Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Y	N		
Intervideo WinDVD (DVD player/burner software)	Y	N		
HP ProtectTools Security	Y	N		See No 3
PDF Complete - Corporate Edition	Y	N		
HP Support Assistant	Y	N		
HP Power Assistant	Y	N		
MS Office Home & Business 2010	Y	N		See No 4

NOTE 1: Supports Windows 7 only. Preinstalled with every Windows 7 order; Also available as a free download from www.hp.com/go/performanceadvisor
NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise, Windows XP
Professional and Enterprise, and RHEL 6
NOTE 3: Available Q3 2012. Must be selected as a Configure to Order option. Delivered in the form of a "Drop in the Box" CD.
NOTE 4: Must be selected as a Configure-to-Order option. Requires user activation.

Supported Components

Operating Systems	Support Notes
Genuine Windows® 7 Ultimate 64-bit	
Genuine Windows® 7 Professional 32-bit	See http://www.microsoft.com/windows/windows-7 for support details.
Genuine Windows® 7 Professional 64-bit	See http://www.microsoft.com/windows/windows-7 for support details.
Genuine Windows® 7 Home Premium 32-bit	See http://www.microsoft.com/windows/windows-7 for support details.
Genuine Windows® 7 Home Premium 64-bit	See http://www.microsoft.com/windows/windows-7 for support details.
HP Linux Installer Kit	See: http://www.hp.com/workstations/software/linu
Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	See http://www.redhat.com/rhel/desktop/
SUSE Linux Enterprise Desktop 11	See http://www.suse.com/products/desktop/

Windows XP Pro 32-bit/64-bit OS supported. Drivers available on HP support web site.

System Board		
System Board Form Factor	BTX 21.2mm x 26.7mm	
Processor Socket	Single LGA 1155	
CPU Bus Speed	DMI	
Chipset	Intel® PCH C216	
Memory Expansion Slots	4 DDR3 memory slots	
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC & non-ECC	
Memory Modes	Non-Interleaved for single channel. Interleaved when both channels are populated.	
Memory Speed Supported	1600MHz DDR3	
Memory Protection	ECC available on data	
Maximum Memory	32GB	
Memory Configuration (Supported)	2GB, 4GB and 8GB ECC and non-ECC unbuffered DIMMs are supported, but not if mixed.	
	NOTES: Maximum memory capacities assume 64-bit operating systems, such as genuine Genuine Windows® 7 Professional 64-Bit and Red Hat Linux 64-bit. Genuine Windows Vista Home 32 and XP Professional (32-bit) support up to 4 GB. 32-bit Linux supports up to 8 GB.	
PCI Express Connectors	1 PCI Express Gen3 x16 LP slot (x16 electrical/x16 mechanical) 1 PCI Express Gen2 x16 LP slot (x4 electrical/x16 mechanical) 1 PCI Express Gen2 x1 LP slot (x1 electrical/x1 mechanical) **NOTE:** LP = low profile **NOTES:** In the PCIe Gen3 slot (x16 electrical/x16 mechanical) slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.	
PCI Connectors (5.0V)	1 PCI LP slot	
Supported Drive Interfaces	**SATA**	Integrated (4) Serial ATA interfaces (2x 6Gb/s SATA in blue, 2x 3Gb/s SATA in black). One port can optionally be used for eSATA. **NOTE:** the Z220 SFF supports a maximum of two SATA/SSD drives only. RAID 0 and 1 supported. (Factory integrated RAID is Microsoft Windows only).
	Serial Attached SCSI	None
	Integrated RAID	**NOTE:** Requires identical hard drives (speeds, capacity, interface)
	Integrated Graphics	Integrated Intel HD Graphics (on Pentium G640 processor); Integrated Intel HD Graphics 4000 (on Core i7-3xxx processors); Integrated Intel HD Graphics P4000 (on Intel Xeon E3-12x5v2 processors). Unified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display. Support for Microsoft DirectX® 10.1; OpenGL 3.0 on Intel HD Graphics P4000; 1 DisplayPort and 1 VGA graphics port integrated in motherboard; Supports dual displays across DP & VGA outputs
	Network Controller	Integrated Gbit LAN MAC by Intel PHY Lewisville 82579LM; Management capabilities WOL, PXE 2.1 and AMT 8

	External SATA (eSATA)	1 port eSATA capable with optional eSATA After-Market Option cable kit.
	IDE connector	No
	Floppy connector	No
	Serial	1 rear port
	2nd Serial	Yes- requires optional Serial Port Adapter Kit
	Parallel	1 internal header (optional parallel port adapter required)
	CD-ROM input (Audio)	No
	AUX input (Audio)	No
IEEE 1394 Connector(s)	**Front**	No
	Rear	2 IEEE 1394b (requires optional PCIe 1394b card)
	Internal	No
USB Connector(s)	**Front**	4 USB 2.0
	Rear	4 USB 3.0, 2 USB 2.0
	Internal	4 USB 2.0
HD Integrated Audio	Yes	
Flash ROM	Yes	
CPU Fan Header	Not applicable - passive CPU heatsink	
Chassis Fan Header	Yes	
Front Control Panel/Speaker Header	Yes	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	Integrated TPM 1.2. The TPM module disabled where restricted by law, i.e. Russia.	
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes	
Clear Password Jumper	Yes	
Keyboard/Mouse	USB or PS/2	
	240W, 90% efficiency	
Operating Voltage Range	90-264 VAC	
Rated Voltage Range	100-240 VAC	
Rated Line Frequency	50-60 Hz	
Operating Line Frequency Range	47-63 Hz	
Rated Input Current	4A @ 100-240V	
Heat Dissipation	Typical 546 btu/hr (138 kg-cal/hr)Maximum 941 btu/hr (237 kg-cal/hr)	
Power Supply Fan	92x25 mm variable speed	
ENERGY STAR® qualified (Config Dependent)	Yes	
80 PLUS Compliant	Yes, Gold. For the PSU Efficiency Report for the power supply, please go to these links: http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_PS-4241-	

	9HB_ECOS%202398_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_PC9055-020H_ECOS%202342_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_D10-240P1A_ECOS%202307_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HP_DPS-240TB%20A_ECOS%202299_240W_Report.pdf http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_CFH240EWWB_ECOS%202304_240W_Report.pdf
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)	Yes, Configuration dependent
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
Power consumption in sleep mode (as defined by ENERGY STAR) **- Suspend to RAM** (S3)	<4W
Built-in Self Test (BIST) **LED**	No
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5- Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5- Power Off)	Yes
Declared Noise Emissions (Entry-level and High-end configurations)	Declared Noise Emissions (Entry-level and High-end configurations)

System Configuration

Example Configuration #1	To be advised later with the Intel Core i3 processor introduction.

Example Configuration #2	**Processor Info**	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GT0 CPU
	Memory Info	4GB (2x 2GB) 1600 MHz DDR3 ECC
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics
	Disks/Optical/Floppy	1x SATA 1 TB 7.2k rpm/ 1 Optical
	PSU	240W 90%
	OS /BIOS	Win7 64/v 0.9

System Technical Specifications

Energy Consumption		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	44.3 W		45.1 W		44.4 W	
	Windows Busy Typ (S0)	153.7 W		150.8 W		154.2 W	
	Windows Busy Max (S0)	172.5 W		170.3 W		176.2 W	
	Sleep (S3)	2.63 W	2.50W	2.65 W	2.53 W	2.64 W	2.50W
	Off (S5)	1.21 W	1.06 W	1.22 W	1.08 W	1.23 W	1.05 W
	Zero Power Mode (EuP)	0.26 W		0.33 W		0.26W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	151.2 btu/hr		153.9 btu/hr		151.5 btu/hr	
	Windows Busy Typ (S0)	524.4 btu/hr		514.5 btu/hr		526.1 btu/hr	
	Windows Busy Max (S0)	588.6 btu/hr		581.1 btu/hr		601.2 btu/hr	
	Sleep (S3)	8.97 btu/hr	8.53 btu/hr	9.04 btu/hr	8.63 btu/hr	9.00 btu/hr	8.53 btu/hr
	Off (S5)	4.12 btu/hr	3.62 btu/hr	4.16 btu/hr	3.68 btu/hr	4.20 btu/hr	3.58 btu/hr
	Zero Power Mode (EuP)	0.89 btu/hr		1.13 btu/hr		0.89 btu/hr	

Example Configuration #3		
	Processor Info	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GT0 CPU
	Memory Info	32GB (4x 8GB) 1600 MHz DDR3 ECC
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics
	Disks/Optical/Floppy	2x SATA 1 TB 7.2k rpm/ 1 Optical
	PSU	240W 90%
	OS /BIOS	Win7 64/v 0.9

Energy Consumption		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	55.0 W		56.5 W		55.3 W	
	Windows Busy Typ (S0)	163.5 W		165.6 W		165.2 W	
	Windows Busy Max (S0)	186.6 W		195.0 W		189.5 W	
	Sleep (S3)	3.44W	3.30 W	3.52 W	3.06 W	3.41 W	3.28 W
	Off (S5)	1.20 W	1.02 W	1.26 W	1.01 W	1.20 W	1.00 W
	Zero Power Mode (EuP)	0.27 W		0.34 W		0.25W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	187.7 btu/hr		192.8 btu/hr		188.7 btu/hr	
	Windows Busy Typ (S0)	557.9 btu/hr		565.0 btu/hr		563.7 btu/hr	
	Windows Busy Max (S0)	657.2 btu/hr		665.3 btu/hr		646.6 btu/hr	
	Sleep (S3)	11.74 btu/hr	11.26 btu/hr	12.01btu/hr	10.44 btu/hr	11.63 btu/hr	11.19 btu/hr
	Off (S5)	4.09 btu/hr	3.48 btu/hr	4.30 btu/hr	3.45 btu/hr	4.09 btu/hr	3.41 btu/hr

	Zero Power Mode (EuP)	0.92 btu/hr	1.16 btu/hr	0.85 btu/hr

NOTES:
* Energy Star low energy mode
** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)		
System Configuration (Entry level)	**Processor Info**	Intel Core i7-3770 3.4 GHz
	Memory Info	2 x 2GB DDR3 1600 MHz
	Graphics Info	Integrated Intel HD Graphics 4000
	Disks/Optical	1x 250 GB 7200 RPM SATA HDD; SATA Blu-ray ODD

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		**Sound Power** (LWAd, bels)	**Deskside Sound Pressure** (LpAm, decibels)
	Idle	3.2	21
	Hard drive Operating (random reads)	3.4	23
	DVD-ROM Operating (sequential reads)	4.99	42

System Configuration (High-end)	**Processor Info**	System Configuration (High-end)
	Memory Info	4 x 4GB DDR3 1600 MHz
	Graphics Info	NVIDIA Quadro 600
	Disks/Optical	2x 300GB 10K rpm SATA HDDs; SATA Blu-ray ODD

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		**Sound Power** (LWAd, bels)	**Deskside Sound Pressure** (LpAm, decibels)
	Idle	3.4	24
	Hard drive Operating (random reads)	4.3	29
	DVD-ROM Operating (sequential reads)	5.0	42

System Technical Specifications

Environmental Requirements	**Temperature**	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz **NOTES:** Values represent individual shock events and do not indicate repetitive shock events.Values do not indicate continuous vibration.
	Cooling	Above 5,000 ft (1524 m) altitude, maximum operating temperature is de-rated by 1.8° F (1° C) per 1,000 ft (305 m) elevation increase

Physical Security and Serviceability	
Access Panel	Tool-less Includes system board and memory information
Expansion Cards	Tool-less
Processor Socket	Tool-less, except for the processor heatsink.
Green User Touch Points	Yes, on tool-free internal chassis mechanisms
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Restores the system to the factory shipped operating system. Orderable with the system and available from HP Support.
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system

System Technical Specifications

Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power Supply Diagnostic LED	No
Front Power Button	Yes, ACPI multi-function
Front Power LED	Yes, blue (normal), red (fault)
Front Hard Drive Activity LED	Yes, green
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
Cooling Solutions	Air cooled forced convection
Power Supply Fans	92 mm x 92 mm x 25 mm 4-wire PWM (non-serviceable)
CPU Heatsink Fan	Not applicable- CPU heatsink is passive.
Chassis Fan	92 mm x 92mm x 25 mm 4-wire PWM
Memory Heatsink Fan	No
HP Advanced System Diagnostics Offline Edition	HP Advanced System Diagnostics enables you to perform hardware testing and view hardware and software configuration. HP Advanced System Diagnostics is provided on systems shipped with Windows and available as a download from HP Support.
Access Panel Key Lock	No
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). ● Allows the system to wake from a low power mode. ● Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system

Trusted Platform Module Chip with optional ProtectTools Software	Yes
Integrated Chassis Handles	No
Power Supply	Tool-less
PCI Card Retention	Yes, rear (all), middle (none), front (none)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux

BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7.1, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes: • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.

System Technical Specifications

ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
ASF 2.0 Compliant	No.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.
Asset Tag	The user or IT administrator to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Intel® Active Management Technology (AMT)	AMT 8.0; Allows workstation status to be monitored on a remote console
Digitally and Cryptographically Signed BIOS	Helps to prevent the installation of unauthorized versions of a BIOS (a rogue BIOS) from a virus, malware, or other code that could lead to compromised system security, data access, physical service, or even system board replacement.
Master Boot Record Protection	A feature in the HP BIOS that prevents changes and/or infections to the Master Boot Record. Useful in protecting from viruses.
Boot Block Emergency Recovery Mode (BIOS Recovery)	The HP BIOS offers a write-protected boot block ROM that provides recovery from a failed flashing of the computer BIOS. This special recovery mode prevents the system from becoming unusable or "bricked" when a BIOS update is interrupted.
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c

System Technical Specifications

ASF	Alert Standard Format Specification, Version 2.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0; PCI Express Base Specification, Revision 3.0.
PMM	POST Memory Manager Specification, Version 1.01
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA II: Extensions to Serial ATA 1.0, Revision 1.0a - Serial ATA II Cables and Connectors Volume 2 Gold - SATA-IO SATA Revision 3.0 Specification
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification
UEFI	UEFI 2.3.1

Social and Environmental Responsibility

Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and ma be labeled with one or more of these marks: • ENERGY STAR® (energy-saving features available on selected configurations -Windows only) • US Federal Energy Management Program (FEMP) • China Energy Conservation Program (CECP) • IT ECO declaration
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal Batteries used in the product do not contain: • Mercury greater than 5ppm by weight • Cadmium greater than 10ppm by weight • Lead greater than 40 ppm by weight.
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the the Environment: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directiv on a worldwide basis. This product is brominated flame retardant and polyvinyl chloride free (BFR/PVC-free); meeting the evolving definition of "BFR/PVC-free" as set forth in the "iNEMI Position Statement on the 'Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free).'" Plastic parts contain <1,000 ppm (0.1 percent) of bromine (if the Br source is from BFRs) and <1,000 ppm (0.1 percent) of chlorine (if the Cl source is from CFRs or PVC or PVC copolymers). All printed circuit board (PCB) and

	substrate laminates contain bromine/chlorine total <1,500 ppm (0.15 percent) with a maximum chlorine of 900 ppm (0.09 percent) and maximum bromine being 900 ppm (0.09 percent). Service parts after purchase may not be BFR/PVC-free. Exceptions to this claim that may be shipped w the product include the power cord, keyboard, mouse and video adapters which may not be BFR/PVC-free.
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Additional Information	• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC. • This HP product is designed to comply with the Waste Electrical and Electronic Equipmer (WEEE) Directive - 2002/96/EC. • Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. • This product contains 0% recycled materials (by weight) • This product is >90% recycle-able when properly disposed of at end of life. For more details on the following please refer to the respective sections: • Energy Consumption and Power Supply Efficiency • Heat Dissipation • Declared Noise Emissions
Packaging	This product meets the packaging requirements specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency.
Packaging Materials	
Internal	EPE - Expanded Polyethylene, Polyethylene low density foam. The EPE - Expanded Polyethylene packaging material is made from 100% recycled content The Polyethylene low density foam packaging material is made from 100% recycled content
External	Corrugated Carton. The Corrugated Carton packaging material is made from 100% recycled content.

Manageability

Intel Active Management Technology (AMT)	An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect network client systems regardless of the system's health or power state. AMT 8.0 includes the following advanced management functions: • Power Management (on, off, reset) • Hardware Inventory (includes BIOS and firmware revisions • Hardware Alerting • Agent Presence • System Defense Filters • SOL/IDER • Cisco NAC/SDN Support • ME Wake-on-LAN • DASH 1.1 compliance • IPv6 Support • Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection • Remote Scheduled Maintenance - pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient • Remote Alerts - automatically alert IT or service provider if issues arise • Access Monitor - Provides oversight into Intel® AMT actions to support security requirements • PC Alarm Clock • Microsoft NAP Support • Host Base set-up and configuration • Management Engine (ME) firmware roll back • Wireless AMT functionality on Desktop (WoDT) • Enhanced KVM resolution
Intel® vPro™ Technology	The HP Z220 workstations support Intel vPro technology when purchased with a vPro technology capable CPU: Intel® Xeon® processor E3-1200v2 family or 3rd Generation Intel Core i5/i7 processors with Intel VT and Intel TXT technology
Remote Manageability Software Solutions	Visit: http://www.hp.com/go/easydeploy
System Software Manager	Visit: http://www.hp.com/go/ssm
Service, Support, and Warranty	• Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. • PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. • Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduc this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life These components and their corresponding HP Workstation platform compatibility are outlined ir this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	**Product #**	**Offering**
	A8Y07AV	Intel® Xeon® processor E3-1280v2, 3.6/4.0GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology
	A8Y04AV	Intel® Xeon® processor E3-1240v2, 3.4/3.8GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology
	A8Y02AV	Intel® Xeon® processor E3-1225v2, 3.2/3.6GHz, 77W, 8 MB cache, 1600 MHz memory, Quad-Core, no HT, Intel® HD Graphics P4000, featuring Intel® vPro Technology
Hard Drives	**Product #**	**Offering**
	A8X40AV	1TB 7200 RPM SATA 6G 1st HDD
	A8X52AV	1TB 7200 RPM SATA 6G 2nd HDD
	A8X39AV	500GB 7200 RPM SATA 6G 1st HDD
	A8X51AV	500GB 7200 RPM SATA 6G 2nd HDD
Graphics	**Product #**	**Offering**
	A7U41AV	NVIDIA NVS 310 512MB Graphics
	A7U42AV	NVIDIA NVS 310 512MB 2nd Graphics
Memory	**Product #**	**Offering**
	A8Y23AV	16GB DDR3-1600 ECC (4x4GB) RAM
	B4Y02AV	12GB DDR3-1600 ECC (2x4GB+2x2GB) RAM
	A8Y22AV	8GB DDR3-1600 ECC (2x4GB) RAM
	A8Y21AV	8GB DDR3-1600 ECC (4x2GB) RAM
	A8Y20AV	4GB DDR3-1600 ECC (2x2GB) RAM
	A8Y19AV	2GB DDR3-1600 ECC (1x2GB) RAM
Optical and Removable Storage	**Product #**	**Offering**
	A8X92AV	16X SuperMulti DVDRW SATA 1st ODD
Operating Systems	**Product #**	**Offering**
	A3J50AV	Genuine Windows® 7 Professional 64-bit

Processors	Intel® Xeon® processor E3-1280v2, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology
	Intel® Xeon® processor E3-1270v2, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology
	Intel® Xeon® processor E3-1245v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology
	Intel® Xeon® processor E3-1240v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology
	Intel® Xeon® processor E3-1230v2, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology
	Intel® Xeon® processor E3-1225v2, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology
	Intel® Core™ i7-3770 processor, Quad-Core, 8 MB cache, 3.4GHz, up to 3.9 GHz with Intel Turbo Boost Technology
	Intel® Pentium® G640 processor, Dual-Core, 3 MB cache, 2.8 GHz

SATA (Serial ATA) Hard Drives for HP Workstations	**300GB SATA 10K rpm SFF in 3.5" Frame HDD**	**Capacity**	300,069,052,416 bytes	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	2.5 in; 6.36 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (3.0 Gb/s), Native Command Queuing enabled	
		Synchronous Transfer Rate (Maximum)	Up to 300 MB/s	
		Cache	16 MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	0.7 ms (maximum)
			Average	4.4 ms
			Full Stroke	9.5 ms
		Rotational Speed	10,000 rpm	
		Logical Blocks	586,072,368	
		Operating Temperature	41° to 131° F (5° to 55° C)	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	1 Terabyte (1000 GB)	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NCQ enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
		Buffer	32MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2 ms
			Average	11 ms
			Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	1,953,525,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	500GB	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NCQ enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Buffer	16MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2 ms
			Average	11 ms
			Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	

	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	250 GB	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NCQ enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Buffer	8 MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2 ms
			Average	11 ms
			Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	488,397,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	2TB	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0 Gb/s), NCQ Enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Buffer	64MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	1.0 ms
			Average	11 ms
			Full Stroke	18 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	3,907,029,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	
HP Solid State Drives (SSDs) for Workstations	**HP 160GB SATA SSD**	**Capacity**	160GB	
		Width	**Media Diameter**	NaN in; NaN cm
			Physical Size	2.5 in; 6.36 cm
		Interface	SATA	
		Synchronous Transfer Rate (Maximum)	3Gb/s	
		Operating Temperature	32° to 158° F (0° to 70° C)	
	HP 300GB SATA SSD	**Capacity**	300GB	
		Width	**Physical Size**	2.5 in; 6.36 cm
		Interface	SATA	
		Synchronous Transfer Rate (Maximum)	3Gb/s	
		Operating Temperature	32° to 158° F (0° to 70° C)	

NVIDIA NVS 300 512MB Graphics Card	**Form Factor**	2.7 inches (H) x 5.7 inches (L), Half-Height
	Graphics Controller	NVIDIA NVS 300 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	512 MB GDDR3 SDRAM unified graphics memory
	Connectors	DMS-59 Includes DMS-59 to Dual DVI-I adapter DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapte available as an option DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display
	Maximum Resolution	DVI: two digital displays up to 1920 x 1200 DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080
	Image Quality Features	
	Display Output	This card support up to two displays: • Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking • Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter) • Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)
	Supported Graphics APIs	OGL 3.3 DirectX 10.1
	Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Power Consumption	<18 Watts

NVIDIA NVS 310 512MB Graphics Card	**Form Factor**	Low Profile: 2.713 inches in height × 6.150 inches in length
	Graphics Controller	NVIDIA NVS 310
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size: 512MB DDR3 Clock: 875Mhz Memory Bandwidth: 14GB/s
	Connectors	2 x DisplayPort 1.2
	Maximum Resolution	Up to 2560 x 1600 (digital display) per display.
	Image Quality Features	See Display Output section. The following video formats are supported: • MPEG2 •

- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support
- Support for 3D Blu Ray
- VC1
- DivX version 3.11 and later
- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up t 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz wi reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 H with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

- NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

- Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

DX11, OpenGL 4.1

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit)
Microsoft Windows XP Professional (64-bit and 32-bit)
Red Hat Enterprise Linux(RHEL)
SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:
http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from:
ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

19.5 Watts

	Note	The thermal solution used on this card is an active fan heatsink.
AMD FirePro V3900 1GB Graphics Card	**Form Factor**	Full height, half length (full-height bracket included)
	Graphics Controller	AMD FirePro™ V3900 professional graphics
	Bus Type	PCI Express® x16, Generation 2.1
	Memory	1GB DDR3 memory
	Maximum Resolution	2560x1600 per display (5120x1600 max. horizontal resolution)
	Display Output	1 DisplayPort® 1.2 1 Dual-link DVI
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2
	Available Graphics Drivers	Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Power Consumption	<50W
	Note	AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See www.amd.com/firepro for details.
NVIDIA Quadro 600 1GB Graphics Card	**Form Factor**	2.731" H x 6.6" L Single Slot Small Form Factor
	Graphics Controller	NVIDIA Quadro 600 Graphics Card
	Bus Type	PCI Express 2.0 x16
	Memory	1 GB GDDR3 128-bit
	Connectors	1 DVI-I output, 1DisplayPort output One DP to DVI adapter included with card DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available as accessories
	Maximum Resolution	DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)
	Shading Architecture	Shader Model 5.0

Technical Specifications - Graphics

	Supported Graphics APIs	OpenGL 4.0 DirectX 11 CUDA API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
	Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3 bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Power Consumption	40 Watts
NVIDIA Quadro 410 512MB Graphics	**Form Factor**	Low Profile: 2.713 inches × 5.7 inches, single slot
	Graphics Controller	NVIDIA Quadro 410
	Bus Type	PCI Express x16, 3.0 compliant
	Memory	Size: 512MB DDR3 Clock: 900MHz Memory Bandwidth: 14GB/s
	Connectors	One dual-link DVI-I connector One DisplayPort connector
	Maximum Resolution	Up to 2560 x 1600 (digital display) per display.
	RAMDAC	400 MHz integrated RAMDAC
	Display Output	Maximum resolution over DisplayPort: 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking) Maximum resolution over DVI port: 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking) Maximum resolution over VGA (through DVI to VGA cable): 2048 × 153 × 32 bpp at 85 Hz
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	DX11, OpenGL 4.2
	Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit) HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive	**Description**	5.25-inch, half-height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)	
	Disc Capacity	**DVD-ROM**	Single layer: Up to 4.7 GB Double layer: Up 8.5 GB
	Access Times	**DVD-ROM Single Layer**	< 140 ms (typical)
		CD-ROM Mode 1	< 125 ms (typical)
		Full Stroke DVD	< 250 ms (seek)
		Full Stroke CD	< 210 ms (seek)
	Power	**Source**	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC - < 600 mA typical, < 1400 mA maximum
	Operating Environmental (all conditions non-condensing)	**Temperature**	41° to 122° F (5° to 50° C)
		Relative Humidity	10% to 90%
		Maximum Wet Bulb Temperature	86° F (30° C)
		Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive	**Description**	5.25-inch, half-height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)	
	Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	**DVD-ROM**	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	< 250 ms (seek)
		Full Stroke CD	< 210 ms (seek)

Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	**CD ROM Read**	CD-ROM, CD-R Up to 40X CD-RW Up to 32X	
	DVD ROM Read	DVD-RAM	Up to 12X
		DVD+RW	Up to 8X
		DVD-RW	Up to 8X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 16X
		DVD-R	Up to 16X
Power	**Source**	SATA DC power receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
	DC Current	5 VDC -1000 mA typical, 1600 mA maximur 12 VDC -600 mA typical, 1400 mA maximur	
Operating Environmental (all conditions non-condensing)	**Temperature**	41° to 122° F (5° to 50° C)	
	Relative Humidity	10% to 90%	
	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, (Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11 No driver is required for this device. Native support is provided by the operating system.	
	Kit Contents	HP SATA SuperMulti DVD Writer Drive, Rox Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.	

HP Blu-Ray Writer	**Description**	5.25-inch, half-height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)
	Disc Formats	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Technical Specifications - Optical and Removable Storage

Disc Capacity	**DVD-ROM**	8.5 GB DL or 4.7 GB standard	
	Blu-ray	50 GB DL or 25 GB standard	
	Full Stroke DVD	< 250 ms (seek)	
	Full Stroke CD	< 210 ms (seek)	
	Blu-ray	Blu-ray	
	Startup Time (Time to drive ready from tray loading)	BD-ROM (SL/DL)	25S / 28S
		BD-R (SL/DL)	25S / 28S
		BD-RE (SL/DL)	25S / 28S
		DVD-ROM (SL/DL)	18S / 18S
		DVD-R (SL/DL)	25S / 25S
		DVD-RW	25S
		DVD+R (SL/DL)	25S / 25S
		DVD+RW	25S
		DVD-RAM	45S
		CD-ROM	45S
Maximum Data Transfer Rates	**CD ROM Read**	CD-ROM	Up to 40X
		CD-R	Up to 40X
		CD-RW	Up to 40X
	DVD ROM Read	DVD-RAM	Up to 5X
		DVD+RW	Up to 10X
		DVD-RW	Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 12X
		DVD-R	Up to 12X
	Blu-Ray	BD-ROM	Up to 6X
		BD-ROM DL	Up to 4.8X
		BD-R	Up to 6X
		BD-R DL	Up to 4.8X
		BD-R	Up to 6X
		BD-RE SL/DL	Up to 4.8X
Power	**Source**	SATA DC power receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p	
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximu	
Operating Environmental (all conditions non-condensing)	**Temperature**	41° to 122° F (5° to 50° C)	
	Relative Humidity	15% to 80%	
	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation,	

		SUSE Linux Enterprise Desktop 10 & 11 * No driver is required for this device. Native support is provided by the operating system. ** RHEL WS4 not supported on Z200/Z200SFF
	Kit Contents	HP Blue Laser RW Drive, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide.
	Disclaimer	As Blu-Ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, th may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card Reader	**Description**	The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.
	Mounting Orientation	The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will operate in any orientation.
	Interface Type	USB 2.0 (one channel dedicated to the separate USB port; one channe dedicated to the flash memory card slots)
	Dimensions (WxHxD)	124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)
	Disc Formats	xD-Picture Micro SD Micro SDHC SD SDHC SDXC Mini SD Mini SDHC MultiMediaCard (MMC) Reduced Size MultiMediaCard (RS MMC) MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC) Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mob HC) CompactFlash Card Type I CompactFlash Card Type II MicroDrive Memory Stick (MS) MagicGate Memory Stick (MG) MagicGate Memory Stick Duo Memory Stick Select Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO) Memory Stick PRO Duo (MS PRO Duo) Memory Stick PRO-HG Duo Two additional formats are usable with adapters (not supplied): MMC Micro

Memory Stick Micro (M2)

HP IEEE 1394b FireWire PCIe Card	**Data Transfer Rate**	Supports up to 800 Mbps
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCIe card full height PCIe slots
	Ports	Two IEEE-1394b bilingual 9-Pin Connector (Rear)
	Internal Connectors	One 10-Pin header Custom Connector
	System Requirements	Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-ROM drive, built in sound system, Available PCIe slot.
	Temperature – Operating	50° to 131° F (10° to 55° C)
	Temperature – Storage	–22° to 140° F (–30° to 60° C)
	Relative Humidity – Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and SLED 11.
HP USB 3.0 2x2 Port SuperSpeed PCIe x1 Card	**Dimensions** (HxD)	TBD
	Ports	2 External, 2 internal
	Operating Systems Supported	Microsoft Windows 7, Windows Vista*, Windows XP Professional (32-bit and 64-bit); Red Hat Enterprise Linux 6, SUSE Linux Enterprise Desktop 11 Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.
	Kit Contents	I/O and Security Software and Documentation CD with software drivers and documentation, HP SuperSpeed USB 3.0 PCIe x1 card (with full-height expansion bracket attached), SATA to SATA split power extension cable, Low profile expansion bracket to replace the full-height expansion bracket required on some computer models and HP SuperSpeed USB 3.0 PCIe x1 Card Quick Setup.
	Regulatory Approvals and registrations	FCC 15B, CE EN55022+ EN55024, VCCI, CISPR 22 AS/NZS CISPR 22, LCIE CB service(ITE/AV) IEC 60950-1, Korea EMC, UL USB-IF
	Weight	0.21 lb (95.0 g)
	Warranty	The HP USB 3.0 2x2 Port Super Speed PCIe x1 Card has either a one year limited warranty or the remainder of the warranty of the HP product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions and exclusions apply.

Integrated Intel 82579LM PCIe GbE Controller	**Connector**	RJ-45
	Controller	Intel 82579LM GbE platform LAN connect networking controller
	Memory	24 KB FIFO packet buffer memory
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u
	Bus Architecture	PCI Express and SMBus
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V and 1.05V or just 3.3V with integrated regulators
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic. AMT 7.0 support
Intel Gigabit CT Desktop NIC	**Connector**	RJ-45
	Controller	Intel WG82574L Gigabit Ethernet Controller
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus Architecture	PCI-E 1.0a
	Data Path Width	X1, 250 MB/s, Bi-directional interface
	Data Transfer Mode	Bus-master DMA
	Hardware Certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power Requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T
	Boot ROM Support	Yes
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature	32° to 131°F (0° to 55° C)
	Operating Humidity	85% at 131° F (55° C)
	Dimensions	12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)
	Operating System Driver Support	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64 Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise Desktop (SLED) 11 RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities	WOL , PXE, DMI, WFM 2.0
Kit Contents	Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement